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# Two-Temperature Plasma Modeling of Argon Gas Tungsten Arcs<sup>†</sup>

TASHIRO Shinichi \* and TANAKA Manabu \*\*

## Abstract

*Gas Tungsten Arc (GTA) is suitable as a heat source device for many applications because it can stabilize high temperature arc plasma easily by employing a shielding gas. In many cases, the MHD simulation model assuming a local thermodynamic equilibrium (LTE) is utilized for analyzing the property of the GTA. Although the LTE assumption is effective for evaluating the high temperature region in the arc column, it is difficult to apply it to the low temperature region such as the fringe of the arc column or the sheath regions close to the electrodes due to the decrease of energy exchange. In order to consider the effect of chemical reaction between the arc plasma and the material surface, we have developed a simulation model of the GTA assuming chemical and thermal non-equilibrium. In this paper, as a first step in the study, the heat source property of argon GTA employing a water-cooled copper anode was simulated.*

**KEY WORDS:** (Numerical simulation) (Gas tungsten arc) (Non-equilibrium)

## 1. Introduction

The Gas Tungsten Arc (GTA) is suitable as a heat source device for many applications because it can stabilize high temperature arc plasma easily by employing a shielding gas. The arc plasma is produced between a tungsten cathode and an anode material. GTA has many advantages as a heat source device such as high heating efficiency, highly controllable characteristics and low cost of equipment investment. Therefore, it is widely utilized, for example, for production of nano-particles, material processing such as melting, cutting and welding<sup>1)</sup>, or decomposition, volume reduction and detoxification of toxic waste<sup>2)</sup> and so on.

In many cases, the MHD simulation model assuming a local thermodynamic equilibrium (LTE) is utilized for analyzing the property of the GTA because of short calculation time and suitability to couple with other complex processes<sup>3)</sup>. Under the LTE assumption, all species in the plasma have the same temperature and its chemical composition is determined depending only on the temperature. This assumption is applicable if the arc plasma has high collision frequency between heavy species (neutral gas and ions) and electrons sufficient to exchange their thermal energy. Therefore it is considered to be valid only for high temperature plasma with high electron density.

Although the LTE assumption is effective for evaluating the high temperature region in the arc column, it is difficult to apply it to the low temperature region

such as the fringe of the arc column or the sheath regions close to the electrodes due to a decrease of energy exchange. Especially, in order to consider the effect of chemical reaction between the arc plasma and the material surface such as oxidation, non-equilibrium properties of the arc plasma should be considered without the LTE assumption, since it is required to understand precise properties of the arc plasma close to the material surface.

A number of numerical models of RF plasma considering non-equilibrium effects have been reported<sup>4, 5)</sup>. On the other hand, in case of DC GTA, a thermal non-equilibrium model assuming chemical equilibrium was developed<sup>6)</sup>. Furthermore, a thermal non-equilibrium model including the energy balance between the arc and the electrodes was also reported<sup>7)</sup>. However, the surface area of the cathode spot was assumed in this model. Although a numerical model assuming chemical and thermal non-equilibrium was developed, the energy balance between the arc and the electrodes was ignored<sup>8)</sup>.

Therefore, we have developed a numerical model of GTA assuming chemical and thermal non-equilibrium and including the energy balance between the arc and the electrodes. In this paper, as a first step of the study, the heat source property of argon GTA employing a water-cooled copper anode was simulated.

## 2. Simulation Model

The tungsten cathode, the arc plasma and the Transactions of JWRI is published by Joining and Welding Research Institute, Osaka University, Ibaraki, Osaka 567-0047, Japan

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## Two-Temperature Plasma Modeling of Argon Gas Tungsten Arcs

water-cooled copper anode are described in a frame of cylindrical coordinates with axial symmetry around the arc axis. The calculation domain is shown in **Figure 1**. The diameter and the conical angle of the cathode are 3.2mm and 60degrees, respectively. The electrode gap is 5mm. The arc current is 100A. Ar is introduced at the flow rate of 10L/min. from the outside of the cathode on the upper boundary. The flow is assumed to be laminar. The plasma is optically thin. three component (atoms, ions, electrons), two-temperature argon arc plasma is considered in which atoms and ions have the same translational temperature which is different from that of the electrons. The plasma is assumed to be in chemical (ionization) non-equilibrium and its composition is calculated assuming ionization reactions and diffusion. The other numerical modeling methods are given in detail in our previous papers <sup>9,10</sup>. MHD equations and supplementary equations (1)-(9) are solved iteratively by the SIMPLER numerical procedure <sup>11</sup>.

On the boundaries A-F, C-D and D-F, the temperatures is set to be 300K. The electrical potential is 0V on the boundary C-D and the arc current is given inside the cathode on the boundary A-F. The electron density is  $10^{10}/m^3$  on the boundaries A-F and E-F. Since we neglect the transport of the electrons from the arc plasma to the cathode surface through a cathode sheath, thermal conduction between the electrons and the cathode surface is neglected. On the anode surface B-E, the electron temperature and the electron density can be determined by solving one-dimensional equations of the electron energy conservation and the diffusion along the surface, respectively. In addition, the gradient of each physical quantity in a radial direction is zero on the arc axis A-C because of the axial symmetry.

The mass conservation equation (1) is

$$\nabla \cdot (\rho \vec{u}) = 0$$

The momentum conservation equation (2) is

$$\nabla \cdot (\rho \vec{u} \vec{u}) = -\nabla p + \vec{j} \times \vec{B} + \nabla \cdot \tau, \quad \tau_{\alpha\beta} = \eta \left( \frac{\partial u_\alpha}{\partial x_\beta} + \frac{\partial u_\beta}{\partial x_\alpha} \right)$$

The electron energy conservation equation (3) is

$$\begin{aligned} \vec{u} \cdot \nabla \left\{ n_e \left( \frac{5}{2} k_B T_e + \varepsilon_i \right) \right\} &= \nabla \cdot (k_e \nabla T_e) - \left\{ \varepsilon_i + \left( \frac{5}{2} + \frac{e}{k_B} \frac{\phi}{\sigma} \right) k_B T_e \right\} \dot{n}_e \\ &+ \left( \frac{5}{2} + \frac{e}{k_B} \frac{\phi}{\sigma} \right) \frac{k_B}{e} \vec{j} \cdot \nabla T_e + \vec{j} \cdot \vec{E} - \frac{3m_e}{m_i} n_e (\bar{\nu}_{ei} + \bar{\nu}_{en}) k_B (T_e - T_h) - \dot{R} \end{aligned}$$

The heavy species energy conservation equation (4) is

$$\vec{u} \cdot \nabla \{ (n_e + n_n) k_B T_h \} = \nabla \cdot (k_h \nabla T_h) + \frac{3m_e}{m_i} n_e (\bar{\nu}_{ei} + \bar{\nu}_{en}) k_B (T_e - T_h)$$

The diffusion equation (5) is

$$\vec{u} \cdot \nabla n_e + \nabla \cdot \left\{ \frac{en_e D_{in}}{k_B T_h} \left( \vec{E} - \frac{1}{en_e} \nabla p_i \right) \right\} = \dot{n}_e$$

The current continuity equation (6) is

$$\nabla \cdot \vec{j} = 0$$

The generalized Ohm's law (7) is

$$\vec{j} = \sigma \left( \vec{E} - \frac{1}{en_e} \nabla p_e \right) + \phi \nabla T_e$$

The electric field (8) is

$$\vec{E} = -\nabla \Phi$$

The Maxwell's equation (9) is

$$\nabla \times \vec{B} = \mu_0 \vec{j}$$

where  $x$  is position,  $\rho$  is mass density,  $u$  is velocity,  $n$  is number density,  $T$  is temperature,  $p$  is pressure,  $j$  is current density,  $B$  is self-induced magnetic field,  $\tau$  is stress tensor,  $E$  is electric field,  $\Phi$  is electrical potential,  $\dot{n}_e$  ionization rate,  $D_{in}$  is diffusion coefficient of ions among neutrals,  $\bar{\nu}$ : average collision frequency,  $k_B$  is Boltzmann constant,  $\mu_0$  is permeability of vacuum,  $e$  is elementary charge,  $m$  is mass,  $k$  is translational thermal conductivity,  $\eta$  is dynamic viscosity,  $\phi$  is electron thermodiffusion factor,  $\sigma$  is electrical conductivity,  $\varepsilon_i$  is ionization potential,  $\dot{R}$  is radiation loss, subscript:  $e, i, n$  and  $h$  are electrons, ions, neutrals, and heavy species (ions and neutrals),  $z$  and  $r$  are axial and radial components,  $\alpha$  and  $\beta$  are  $z$  or  $r$ . The transport coefficients are calculated as functions of number density and collision frequency as follows:

$$k_e = a''(T_e) \cdot 3.203 \frac{n_e k^2 T_e}{m_e \nu_{ei}} \quad (10)$$

$$\phi = a'''(T_e) \cdot 1.389 \frac{en_e k}{m_e \nu_{ei}} \quad (11)$$

$$k_h = \frac{15}{8} k \bar{C}_i (n_e \lambda_i + n_n \lambda_n) \quad (12)$$

$$D_{in} = \frac{\bar{C}_i}{\sqrt{2}(n_e + n) \bar{Q}_{in}} \quad (13)$$

$$\sigma = a'(T_e) \cdot 1.975 \frac{n_e e^2}{m_e v_{ei}} \quad (14)$$

where  $\bar{C}$  is average thermal speed,  $\bar{Q}$  is collision cross section and  $a', a''$  and  $a'''$  are factors to express influence of electron-neutral collision. The energy transport due to the ionization reaction is expressed in the second term on the right hand side of equation (4). In addition, the energy transport due to the diffusion was ignored as the previous study<sup>10)</sup>.

In the solution of equations (1)-(9), special account needs to be taken at the electrode surface for effects of energy that only occur at the surface. At the cathode surface, additional energy flux terms need to be considered for radiation cooling, thermionic cooling due to the emission of electrons and ion heating. The additional energy flux for the cathode  $H_k$  is:

$$H_K = -\varepsilon \alpha T^4 - |j_e| \phi_{wc} + |j_i| V_i \quad (15)$$

where  $\varepsilon$  is the surface emissivity,  $\alpha$  is the Stefan-Boltzmann constant,  $\phi_{wc}$  is the work function of the tungsten cathode,  $V_i$  is the ionization potential of argon,  $j_e$  is the electron current density, and  $j_i$  is the ion current density. At the cathode surface, for thermionic emission of electrons,  $j_e$  cannot exceed the Richardson current density  $J_R$ <sup>12)</sup> given by:

$$|j_R| = A T^2 \exp\left(-\frac{e \phi_e}{k_B T}\right) \quad (16)$$

where  $A$  is the thermionic emission constant for the cathode surface,  $\phi_e$  is the effective work function for thermionic emission of the electrode surface at the local surface temperature, and  $k_B$  is the Boltzmann's constant. The ion-current density  $j_i$  is then assumed to be  $|j| - |j_R|$  if  $|j|$  is greater than  $|j_R|$ ; where  $|j| = |j_e| + |j_i|$  is the total current density at the cathode surface obtained from equation (6)

Similarly, for the anode surface, additional energy flux terms need to be considered for radiation cooling, electron enthalpy transport, electron condensation, ion recombination and the additional energy flux for the anode  $H_A$  is:

$$H_A = -\varepsilon \alpha T^4 + \left[ \left( \frac{5}{2} + \frac{e \phi}{k_B T} \right) \frac{k_B T_e}{e} + \phi_{wa} \right] |j_e| + |j_i| V_i \quad (17)$$

where  $\phi_{wa}$  is the work function of the copper and  $|j|$  is the current density at the anode surface obtained from equation (6).

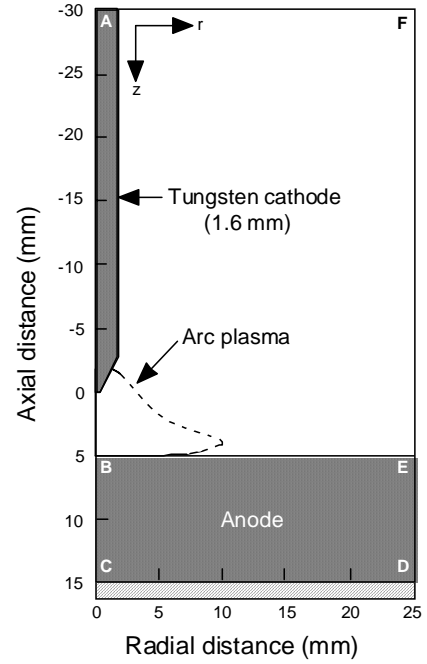


Fig. 1 Schematic illustration of simulation domain.

### 3. Results and Discussion

Figure 2 and 3 show two-dimensional temperature distributions of electron and heavy species in addition to the electrodes, respectively. It is seen that the electron temperature agrees with the heavy species temperature near the arc axis and the LTE approximation is valid in this region. Both temperatures near the cathode tip reach 15000K. This result approximately agrees with experimental results<sup>13)</sup>. On the other hand, it is obvious that in the region close to both electrodes and outside the fringe of the arc column the electron temperature exceeds the heavy species temperature and non-equilibrium characteristics appears. The radius of the arc column seen in the electron temperature distribution is obviously larger than that of heavy species. In addition, the max. surface temperatures of the cathode and anode reach 3600K and 700K, respectively.

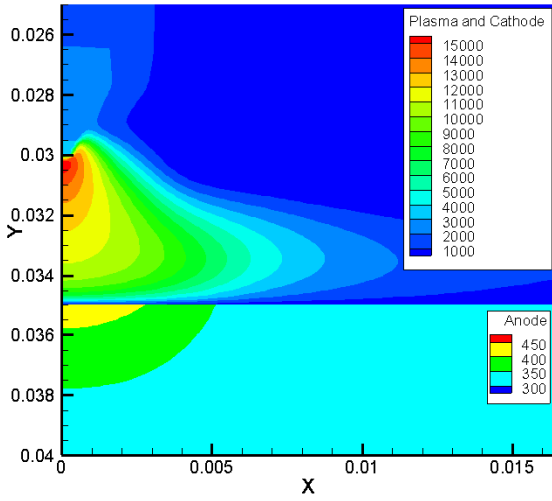
Figure 4 shows dependence of temperature of electron and heavy species near the anode surface on axial distance from the cathode tip. The axial position of 5mm indicates the anode surface. It was found that non-equilibrium property appears in the region where the temperature decreases below 10000K and this region has a thickness of 0.7mm. The temperature difference between electron and heavy species occurs due to the decrease of collision frequency.

Figure 5 shows the dependence of electron density and collision frequency between electron and heavy species near the anode surface on axial distance from the cathode tip. It can be seen that the electron density and the collision frequency decrease with approach to the anode surface. The electron density becomes  $2 \times 10^{22}$  where the plasma temperature decreases to 10000K. Consequently it was found that non-equilibrium property

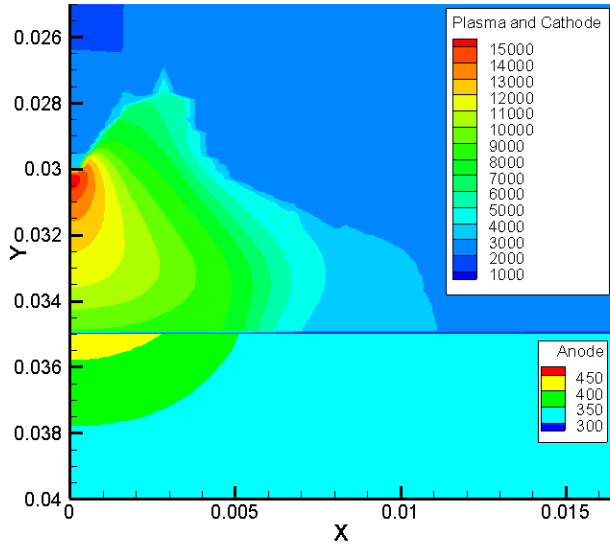
## Two-Temperature Plasma Modeling of Argon Gas Tungsten Arcs

appears below the collision frequency of  $2 \times 10^{11}$  corresponding to this electron density.

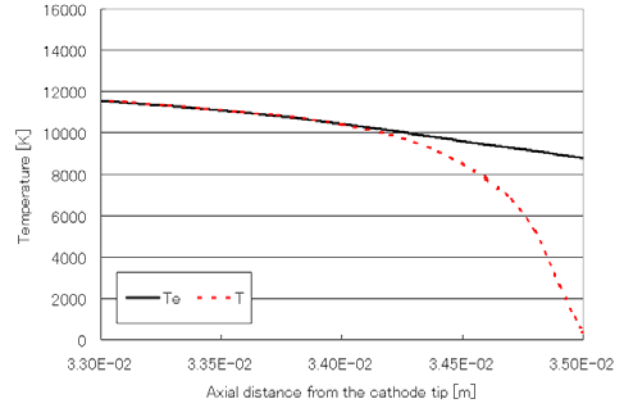
**Figure 6** shows the dependence of heat intensity onto the anode on radial distance from the arc axis. Each component of heat intensity calculated by equation (17), that due to thermal conduction and total heat intensity which is sum of each component are presented. It was found that the heat intensity due to electron absorption onto the anode (electron condensation and electron enthalpy) is significant compared with that of thermal conduction and that of ion recombination is negligibly small.



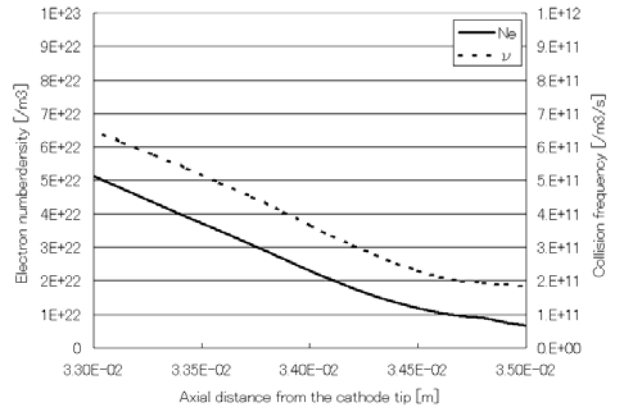
**Fig. 2** Two-dimensional temperature distribution of heavy species and electrodes.



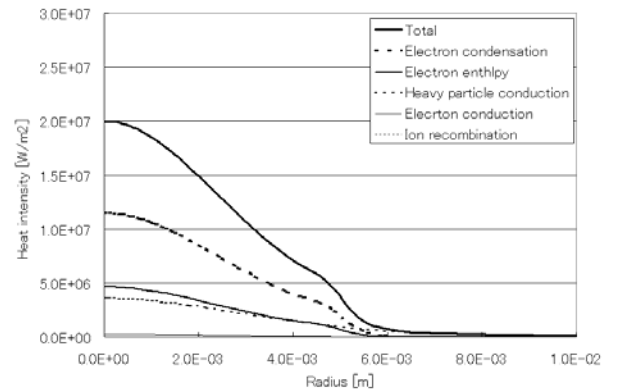
**Fig. 3** Two-dimensional temperature distribution of electron and electrodes.



**Fig. 4** Dependence of temperature of electron and heavy species on axial distance from the cathode tip.



**Fig. 5** Dependence electron density and collision frequency on axial distance from the cathode tip.



**Fig. 6** Dependence of heat intensity at the anode surface on radial distance from the arc axis.

#### 4. Conclusions

The main conclusions are summarized as follows:

- (1) The simulation result of the max. plasma temperature of 15000K approximately agrees with the experimental result.
- (2) The LTE assumption is valid near the arc axis except for the region near the electrodes.
- (3) The non-equilibrium property appears below the collision frequency of  $2 \times 10^{11}$  corresponding to the plasma temperature of 10000K. The thickness of this region becomes approximately 0.7mm near the anode surface.
- (4) The heat intensity onto the anode surface due to electron absorption onto the anode (electron condensation and electron enthalpy) is significant compared with that of thermal conduction and that of ion recombination is negligibly small.

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